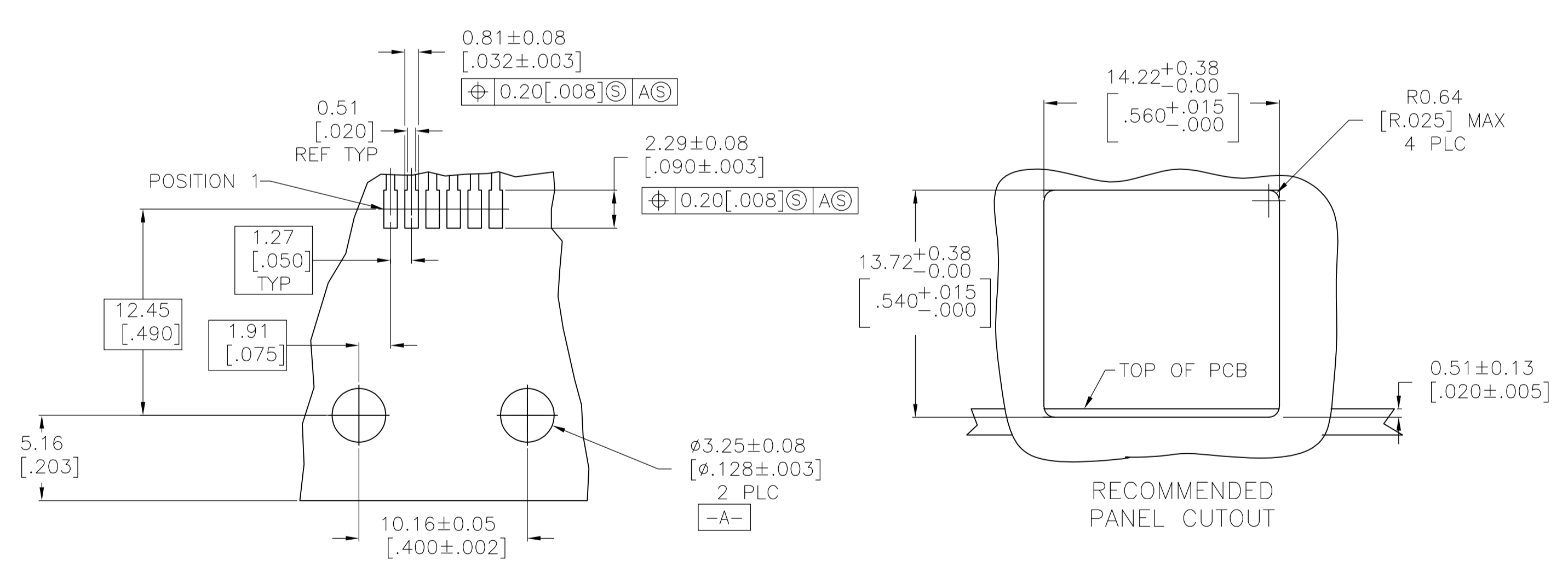
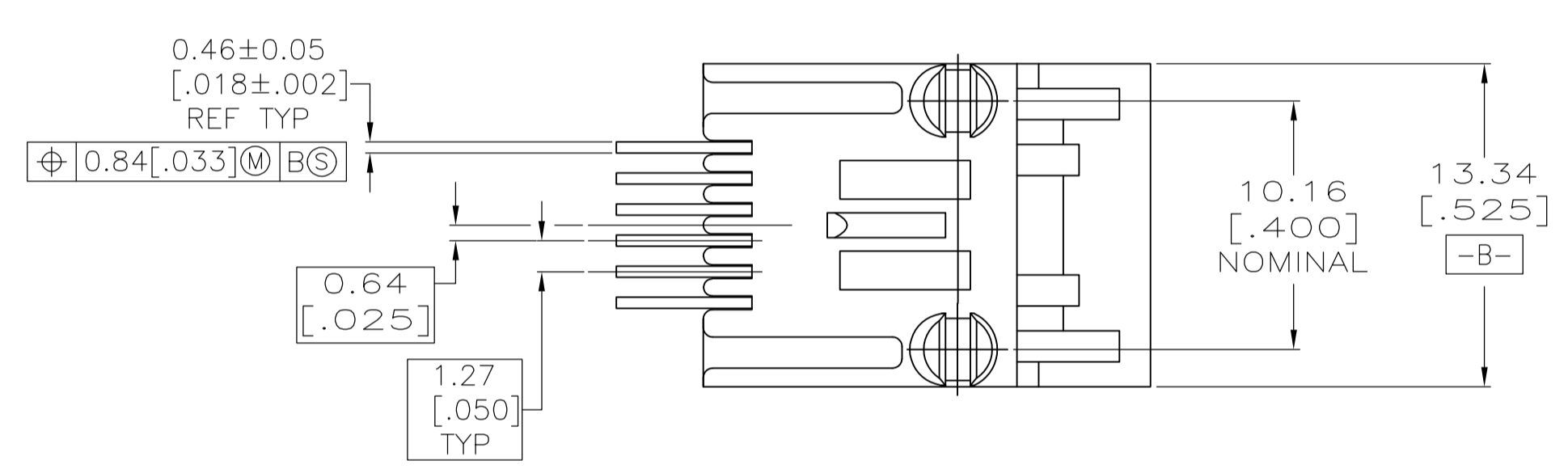


- MATERIAL: HOUSING- HTN MOLDING COMPOUND, 94VO, COLOR: BLACK.
 TERMINAL- 0.36 [.014] THICK PHOS BRONZE PLATED WITH 1.27 μm [.000050] MIN THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 3.81 μm [.000150] THICK MATTE TIN IN SOLDER AREA OVER 1.27 μm [.000050] MIN THICK NICKEL UNDERPLATE.
- CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- SNAP-IN RETENTION FEATURE ACCOMMODATES A 1.57 ± 0.13 [.062 ± .005] PRINTED CIRCUIT BOARD.
- DIMENSIONS ARE MAXIMUM UNLESS OTHERWISE SPECIFIED AND ARE PRIOR TO SURFACE MOUNT PROCESSING.
- TERMINALS SHALL BE ASSEMBLED IN CENTER POSITIONS FOR -2.
- 2 PACKAGED 42 ASSEMBLIES PER TUBE.



RECOMMENDED PRINTED CIRCUIT BOARD COMPONENT SIDE

4	5557314-2
6	5557314-1 (SHOWN)
TERMINALS REQUIRED	PART NO

THIS DRAWING IS A CONTROLLED DOCUMENT.		BIN L.A.MAYER 27AJG2007		TE Connectivity	
DIMENSIONS: mm [INCHES]		CHK P.RECCCE 27AJG2007			
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD S.FLICKINGER 27AJG2007		NAME	
0 PLC ± -		PRODUCT SPEC		MODULAR JACK ASSEMBLY, 6 POSITION, LOW PROFILE, RIGHT ANGLE, SURFACE MOUNT	
1 PLC ± -		APPLICATION SPEC		108-1163	
2 PLC ± -		SIZE		114-8040	
3 PLC ± -		CAGE CODE		A1 00779	
4 PLC ± -		DRAWING NO		5557314	
ANGLES ± ±		RESTRICTED TO		-	
MATERIAL SEE NOTE 1		FINISH SEE NOTE 1		WEIGHT -	
		CUSTOMER DRAWING		SCALE 4:1 SHEET 1 OF 1 REV B1	

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[TE Connectivity:](#)

[5557314-1](#)